## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: JEUN et al.	) I hereby certify that this paper and the
	) documents referred to as being attached or
Serial No.: 09/677,558	) enclosed therewith are being transmitted via
	) EFS-Web to the U.S. Patent and Trademark
Title: SEMICONDUCTOR POWER	) Office on the date indicated:
MODULE HAVING AN	)
ELECTRICALLY INSULATING HEAT	)
SINK AND METHOD OF	)
MANUFACTURING THE SAME	) November 6, 2007
Filed: September 29, 2000	
Group Art Unit: 2814	
•	) Aaron M. Peters
Examiner: NGUYEN, DiLinh P.	) Registration No. 48,801
	) Attorney for Applicants
Atty. Docket Number: 29347/990488	
G	)
Customer No.: 04743	)
	)
Confirmation No.: 1618	)

## RESPONSE TO NON-FINAL OFFICIAL ACTION DATED AUGUST 6, 2007

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

Dear Sir:

In response to the official action dated August 6, 2007, the applicants respectfully request that the application be reconsidered in light of the following amendments and/or remarks.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 6 of this paper.